

## DS90C383A/DS90CF383A +3.3V Programmable LVDS Transmitter 24-Bit Flat Panel Display (FPD) Link-65 MHz +3.3V LVDS Transmitter 24-Bit Flat Panel Display (FPD) Link-65 MHz

### 1.0 General Description

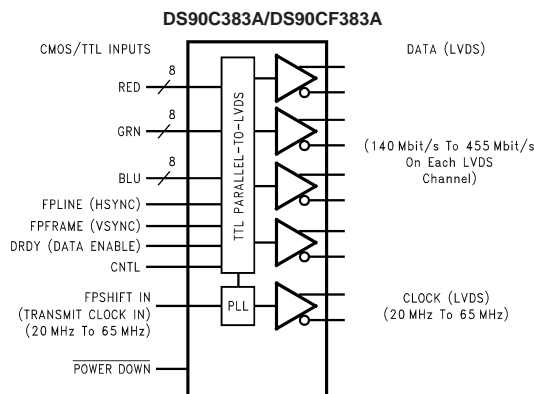
The DS90C383A/DS90CF383A transmitter converts 28 bits of CMOS/TTL data into four LVDS (Low Voltage Differential Signaling) data streams. A phase-locked transmit clock is transmitted in parallel with the data streams over a fifth LVDS link. Every cycle of the transmit clock 28 bits of input data are sampled and transmitted. At a transmit clock frequency of 65 MHz, 24 bits of RGB data and 3 bits of LCD timing and control data (FPLINE, FPFRAME, DRDY) are transmitted at a rate of 455 Mbps per LVDS data channel. Using a 65 MHz clock, the data throughput is 227 Mbytes/sec. The DS90C383A transmitter can be programmed for Rising edge strobe or Falling edge strobe through a dedicated pin. The DS90CF383A is fixed as a Falling edge strobe transmitter. A Rising edge or Falling edge strobe transmitter will interoperate with a Falling edge strobe Receiver (DS90CF384) without any translation logic.

This chipset is an ideal means to solve EMI and cable size problems associated with wide, high speed TTL interfaces.

### 2.0 Features

- 20 to 65 MHz shift clock support
- Rejects  $> \pm 3$ ns Jitter from VGA chip with less than 225ps output Jitter @65MHz (TJCC)
- Best-in-Class Set & Hold Times on TxINPUTs
- Tx power consumption  $< 130$  mW (typ) @65MHz Grayscale
- $> 50\%$  Less Power Dissipation than BiCMOS Alternatives
- Tx Power-down mode  $< 200\mu$ W (max)
- ESD rating  $> 7$  kV (HBM),  $> 500$ V (EIAJ)
- Supports VGA, SVGA, XGA and Dual Pixel SXGA.
- Narrow bus reduces cable size and cost
- Up to 1.8 Gbps throughput
- Up to 227 Megabytes/sec bandwidth
- 345 mV (typ) swing LVDS devices for low EMI
- PLL requires no external components
- Compatible with TIA/EIA-644 LVDS standard
- Low profile 56-lead TSSOP package
- Improved replacement for:  
SN75LVDS83 — DS90C383A  
SN75LVDS81 — DS90CF383A

### 3.0 Block Diagrams



Order Number DS90C383AMTD or DS90CF383AMTD  
See NS Package Number MTD56

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## 4.0 Absolute Maximum Ratings (Note

1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage ( $V_{CC}$ )	-0.3V to +4V
CMOS/TTL Input Voltage	-0.3V to ( $V_{CC} + 0.3V$ )
LVDS Driver Output Voltage	-0.3V to ( $V_{CC} + 0.3V$ )
LVDS Output Short Circuit Duration	Continuous
Junction Temperature	+150°C
Storage Temperature	-65°C to +150°C
Lead Temperature (Soldering, 4 sec)	+260°C
Maximum Package Power Dissipation Capacity @ 25°C	
MTD56 (TSSOP) Package: DS90C383A/DS90CF383A	1.63 W

Package Derating:  
DS90C383A/DS90CF383A 12.5 mW/°C above +25°C

ESD Rating

(HBM, 1.5 kΩ, 100 pF)	> 7 kV
(EIAJ, 0Ω, 200 pF)	> 500V

## 5.0 Recommended Operating Conditions

	Min	Nom	Max	Units
Supply Voltage ( $V_{CC}$ )	3.0	3.3	3.6	V
Operating Free Air Temperature ( $T_A$ )	-10	+25	+70	°C
Receiver Input Range	0		2.4	V
Supply Noise Voltage ( $V_{CC}$ )			100	mV <sub>PP</sub>
TxCLKIN frequency	18		68	MHz

## Electrical Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified.

Symbol	Parameter	Conditions	Min	Typ	Max	Units	
<b>CMOS/TTL DC SPECIFICATIONS</b>							
$V_{IH}$	High Level Input Voltage		2.0		$V_{CC}$	V	
$V_{IL}$	Low Level Input Voltage		GND		0.8	V	
$V_{CL}$	Input Clamp Voltage	$I_{CL} = -18$ mA		-0.79	-1.5	V	
$I_{IN}$	Input Current	$V_{IN} = 0.4V, 2.5V$ or $V_{CC}$		+1.8	+10	μA	
		$V_{IN} = GND$	-10	0		μA	
<b>LVDS DC SPECIFICATIONS</b>							
$V_{OD}$	Differential Output Voltage	$R_L = 100\Omega$	250	345	450	mV	
$\Delta V_{OD}$	Change in $V_{OD}$ between complimentary output states				35	mV	
$V_{OS}$	Offset Voltage (Note 4)		1.125	1.25	1.375	V	
$\Delta V_{OS}$	Change in $V_{OS}$ between complimentary output states				35	mV	
$I_{OS}$	Output Short Circuit Current	$V_{OUT} = 0V, R_L = 100\Omega$		-3.5	-5	mA	
$I_{OZ}$	Output TRI-STATE® Current	Power Down = 0V, $V_{OUT} = 0V$ or $V_{CC}$		±1	±10	μA	
<b>TRANSMITTER SUPPLY CURRENT</b>							
ICCTW	Transmitter Supply Current Worst Case	$R_L = 100\Omega,$ $C_L = 5$ pF, Worst Case Pattern (Figures 1, 4)	$f = 32.5$ MHz		31	43	mA
			$f = 37.5$ MHz		33	45	mA
			$f = 65$ MHz		39	52	mA
ICCTG	Transmitter Supply Current 16 Grayscale	$R_L = 100\Omega,$ $C_L = 5$ pF, 16 Grayscale Pattern (Figures 2, 4)	$f = 32.5$ MHz		23	35	mA
			$f = 37.5$ MHz		28	40	mA
			$f = 65$ MHz		33	45	mA
ICCTZ	Transmitter Supply Current Power Down	Power Down = Low Driver Outputs in TRI-STATE under Power Down Mode		10	55	μA	

**Note 1:** "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the device should be operated at these limits. The tables of "Electrical Characteristics" specify conditions for device operation.

**Note 2:** Typical values are given for  $V_{CC} = 3.3V$  and  $T_A = +25C$ .

**Note 3:** Current into device pins is defined as positive. Current out of device pins is defined as negative. Voltages are referenced to ground unless otherwise specified (except  $V_{OD}$  and  $\Delta V_{OD}$ ).

**Note 4:**  $V_{OS}$  previously referred as  $V_{CM}$ .

## Recommended Transmitter Input Characteristics

Over recommended operating supply and temperature ranges unless otherwise specified

Symbol	Parameter	Min	Typ	Max	Units
TCIT	TxCLK IN Transition Time (Figure 5)			5	ns
TCIP	TxCLK IN Period (Figure 6)	14.7	T	55.6	ns
TCIH	TxCLK IN High Time (Figure 6)	0.35T	0.5T	0.65T	ns
TCIL	TxCLK IN Low Time (Figure 6)	0.35T	0.5T	0.65T	ns

## Transmitter Switching Characteristics

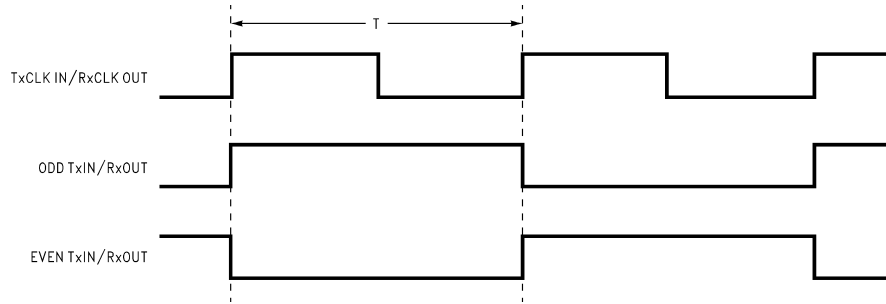
Over recommended operating supply and temperature ranges unless otherwise specified

Symbol	Parameter	Min	Typ	Max	Units	
LLHT	LVDS Low-to-High Transition Time (Figure 4)		0.75	1.5	ns	
LHLT	LVDS High-to-Low Transition Time (Figure 4)		0.75	1.5	ns	
TPPos0	Transmitter Output Pulse Position for Bit 0 (Figure 11) (Note 5)	f = 65 MHz	-0.30	0	0.20	ns
TPPos1	Transmitter Output Pulse Position for Bit 1		1.90	2.20	2.40	ns
TPPos2	Transmitter Output Pulse Position for Bit 2		4.10	4.40	4.60	ns
TPPos3	Transmitter Output Pulse Position for Bit 3		6.30	6.60	6.80	ns
TPPos4	Transmitter Output Pulse Position for Bit 4		8.50	8.80	9.00	ns
TPPos5	Transmitter Output Pulse Position for Bit 5		10.70	11.00	11.20	ns
TPPos6	Transmitter Output Pulse Position for Bit 6		12.90	13.20	13.40	ns
TPPos0	Transmitter Output Pulse Position for Bit 0 (Figure 11) (Note 5)	f = 40 MHz	-0.35	0	0.35	ns
TPPos1	Transmitter Output Pulse Position for Bit 1		3.22	3.57	3.92	ns
TPPos2	Transmitter Output Pulse Position for Bit 2		6.79	7.14	7.49	ns
TPPos3	Transmitter Output Pulse Position for Bit 3		10.36	10.71	11.06	ns
TPPos4	Transmitter Output Pulse Position for Bit 4		13.93	14.28	14.63	ns
TPPos5	Transmitter Output Pulse Position for Bit 5		17.51	17.86	18.21	ns
TPPos6	Transmitter Output Pulse Position for Bit 6		21.08	21.43	21.78	ns
TPPos0	Transmitter Output Pulse Position for Bit 0 (Figure 11) (Note 5)	f = 32.5 MHz	-0.40	0	0.40	ns
TPPos1	Transmitter Output Pulse Position for Bit 1		4.00	4.40	4.80	ns
TPPos2	Transmitter Output Pulse Position for Bit 2		8.40	8.80	9.20	ns
TPPos3	Transmitter Output Pulse Position for Bit 3		12.80	13.20	13.60	ns
TPPos4	Transmitter Output Pulse Position for Bit 4		17.20	17.60	18.00	ns
TPPos5	Transmitter Output Pulse Position for Bit 5		21.60	22.00	22.40	ns
TPPos6	Transmitter Output Pulse Position for Bit 6		26.00	26.40	26.80	ns
TSTC	TxIN Setup to TxCLK IN (Figure 6)	2.5			ns	
THTC	TxIN Hold to TxCLK IN (Figure 6)	0			ns	
TCCD	TxCLK IN to TxCLK OUT Delay (Figure 7) $T_A=25^{\circ}\text{C}, V_{CC}=3.3\text{V}$	3		5.5	ns	
	TxCLK IN to TxCLK OUT Delay (Figure 7)	3		7.0	ns	
TJCC	Transmitter Jitter Cycle-to-Cycle (Figures 12, 13) (Note 6)	f = 65 MHz	175	225	ps	
		f = 40 MHz	240	380	ps	
		f = 32.5 MHz	260	400	ps	
TPLLS	Transmitter Phase Lock Loop Set (Figure 8)			10	ms	
TPDD	Transmitter Power Down Delay (Figure 10)			100	ns	

**Note 5:** The Minimum and Maximum Limits are based on statistical analysis of the device performance over process, voltage, and temperature ranges. This parameter is functionality tested only on Automatic Test Equipment (ATE).

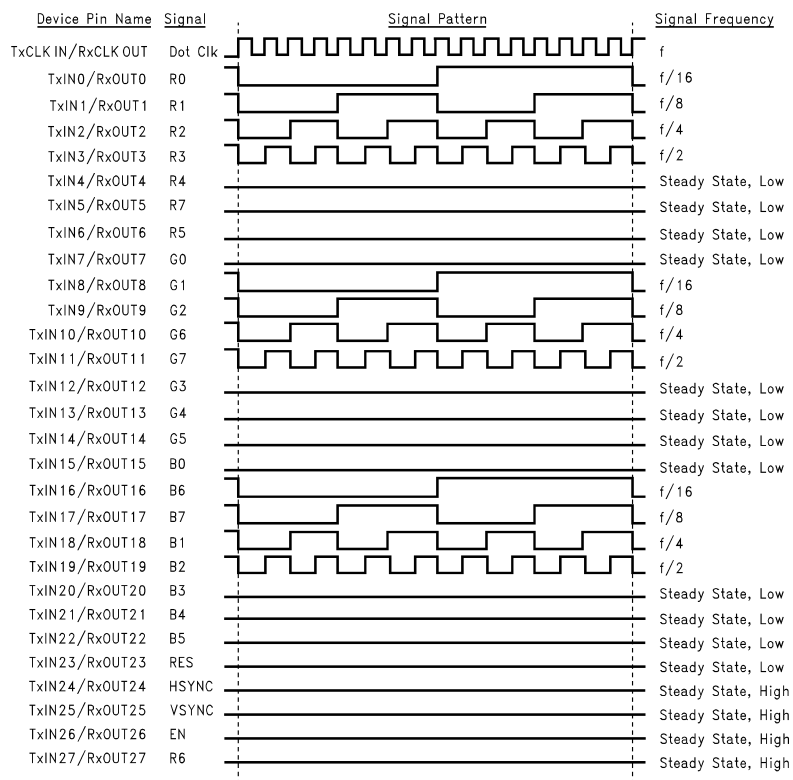
**Note 6:** The Limits are based on statistical analysis of the device performance over process, voltage, and temperature ranges. Output jitter is measured with a cycle-to-cycle jitter of 3ns applied to the input clock signal. A jitter event of 3ns, represents worse case jump in the clock edge from most Graphics controller VGA chips currently available. This parameter is used when calculating system margin (RSKM). See Figures 12, 13 and AN-1059.

## 6.0 AC Timing Diagrams



DS100100-4

FIGURE 1. "Worst Case" Test Pattern



DS100100-5

FIGURE 2. "16 Grayscale" Test Pattern (Notes 7, 8, 9, 10)

**Note 7:** The worst case test pattern produces a maximum toggling of digital circuits, LVDS I/O and CMOS/TTL I/O.

**Note 8:** The 16 grayscale test pattern tests device power consumption for a "typical" LCD display pattern. The test pattern approximates signal switching needed to produce groups of 16 vertical stripes across the display.

**Note 9:** Figures 1, 2 show a falling edge data strobe (TxCLK IN/RxCLK OUT).

**Note 10:** Recommended pin to signal mapping. Customer may choose to define differently.

## 6.0 AC Timing Diagrams (Continued)

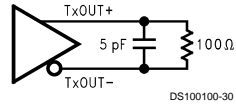


FIGURE 3. DS90C383A/DS90CF383A (Transmitter) LVDS Output Load

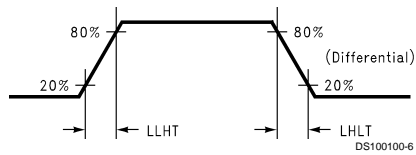


FIGURE 4. DS90C383A/DS90CF383A (Transmitter) LVDS Transition Times

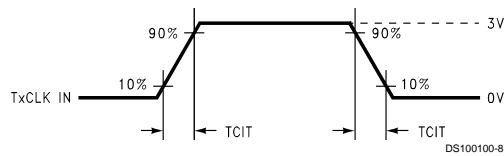


FIGURE 5. DS90C383A/DS90CF383A (Transmitter) Input Clock Transition Time

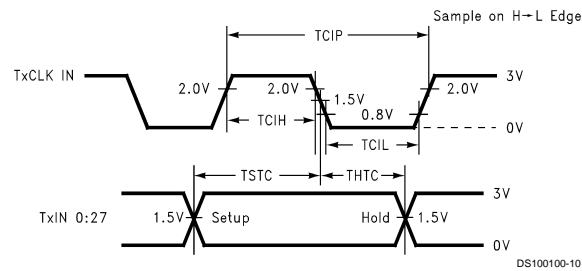


FIGURE 6. DS90C383A/DS90CF383A (Transmitter) Setup/Hold and High/Low Times (Falling Edge Strobe)

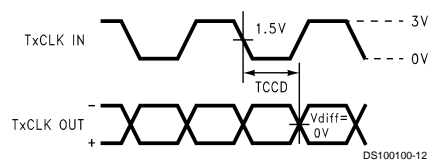


FIGURE 7. DS90C383A/DS90CF383A (Transmitter) Clock In to Clock Out Delay (Falling Edge Strobe)

## 6.0 AC Timing Diagrams (Continued)

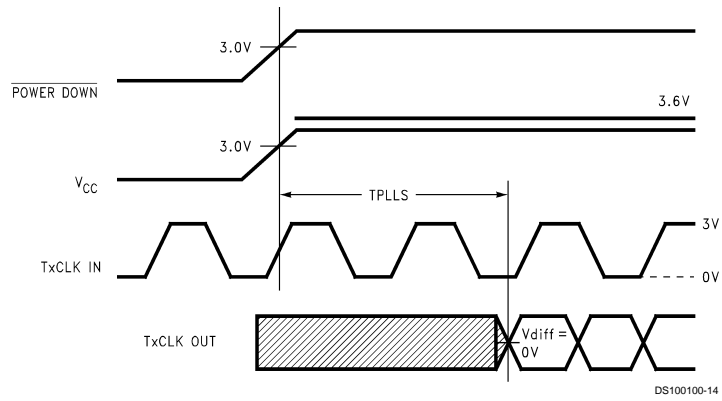


FIGURE 8. DS90C383A/DS90CF383A (Transmitter) Phase Lock Loop Set Time

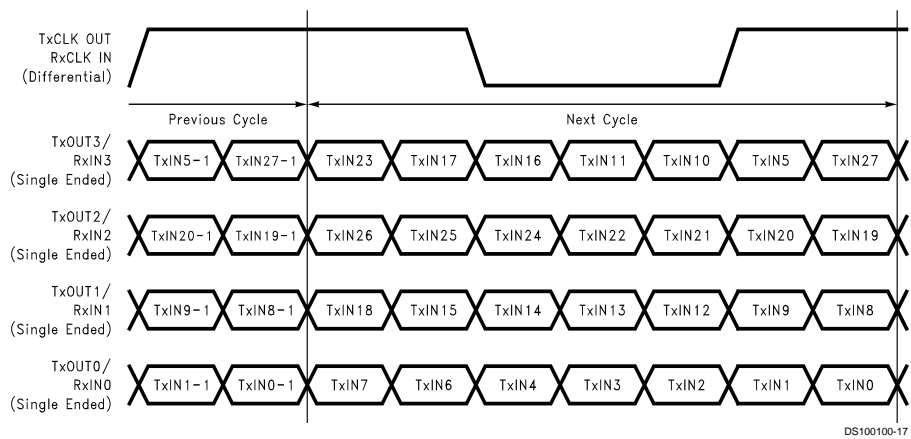


FIGURE 9. 28 Parallel TTL Data Inputs Mapped to LVDS Outputs

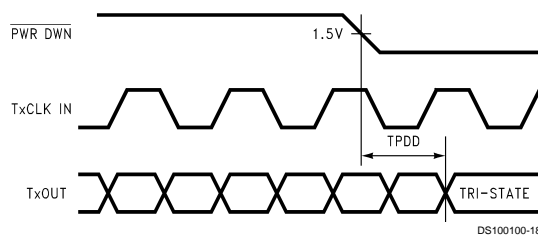
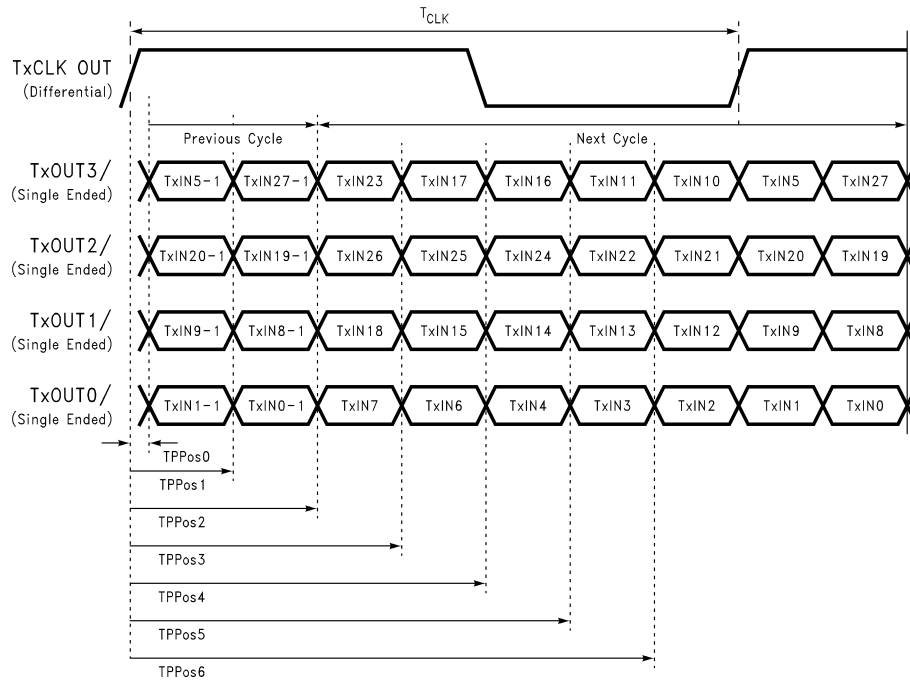


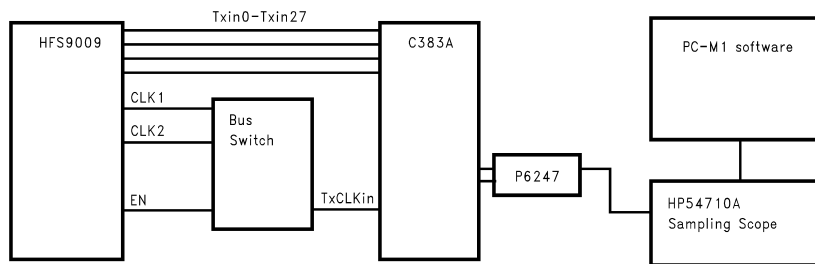
FIGURE 10. Transmitter Power Down Delay

## 6.0 AC Timing Diagrams (Continued)



DS100100-26

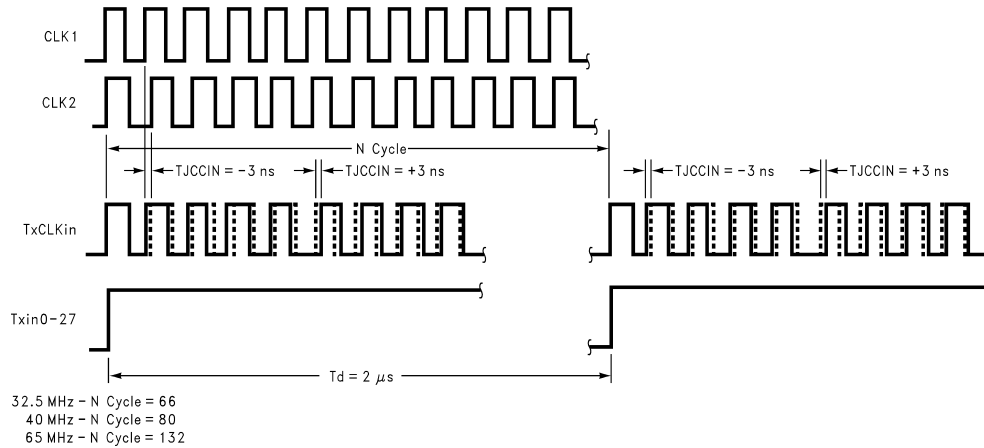
**FIGURE 11. Transmitter LVDS Output Pulse Position Measurement**



DS100100-27

**FIGURE 12. TJCC Test Setup**

## 6.0 AC Timing Diagrams (Continued)



DS100100-28

FIGURE 13. Timing Diagram of the Input cycle-to-cycle clock jitter

## 7.0 DS90C383A Pin Description—FPD Link Transmitter

Pin Name	I/O	No.	Description
TxIN	I	28	TTL level input. This includes: 8 Red, 8 Green, 8 Blue, and 4 control lines— FPLINE, FPFRAME and DRDY (also referred to as HSYNC, VSYNC, Data Enable).
TxOUT+	O	4	Positive LVDS differential data output.
TxOUT-	O	4	Negative LVDS differential data output.
FPSHIFT IN	I	1	TTL level clock input. The falling edge acts as data strobe. Pin name TxCLK IN.
R_FB	I	1	Programmable strobe select (See Table 1).
TxCLK OUT+	O	1	Positive LVDS differential clock output.
TxCLK OUT-	O	1	Negative LVDS differential clock output.
PWR DOWN	I	1	TTL level input. When asserted (low input) TRI-STATES the outputs, ensuring low current at power down.
V <sub>CC</sub>	I	3	Power supply pins for TTL inputs.
GND	I	4	Ground pins for TTL inputs.
PLL V <sub>CC</sub>	I	1	Power supply pin for PLL.
PLL GND	I	2	Ground pins for PLL.
LVDS V <sub>CC</sub>	I	1	Power supply pin for LVDS outputs.
LVDS GND	I	3	Ground pins for LVDS outputs.

## 8.0 DS90CF383A Pin Description—FPD Link Transmitter

Pin Name	I/O	No.	Description
TxIN	I	28	TTL level input. This includes: 8 Red, 8 Green, 8 Blue, and 4 control lines— FPLINE, FPFRAME and DRDY (also referred to as HSYNC, VSYNC, Data Enable).
TxOUT+	O	4	Positive LVDS differential data output.
TxOUT-	O	4	Negative LVDS differential data output.
FPSHIFT IN	I	1	TTL level clock input. The falling edge acts as data strobe. Pin name TxCLK IN.
TxCLK OUT+	O	1	Positive LVDS differential clock output.
TxCLK OUT-	O	1	Negative LVDS differential clock output.
PWR DOWN	I	1	TTL level input. When asserted (low input) TRI-STATES the outputs, ensuring low current at power down.
V <sub>CC</sub>	I	4	Power supply pins for TTL inputs.



## 8.0 DS90CF383A Pin Description—FPD Link Transmitter (Continued)

Pin Name	I/O	No.	Description
GND	I	4	Ground pins for TTL inputs.
PLL V <sub>CC</sub>	I	1	Power supply pin for PLL.
PLL GND	I	2	Ground pins for PLL.
LVDS V <sub>CC</sub>	I	1	Power supply pin for LVDS outputs.
LVDS GND	I	3	Ground pins for LVDS outputs.

## 9.0 Applications Information

The DS90C383A/DS90CF383A are backward compatible with the DS90C383/DS90CF383 and are a pin-for-pin replacement. The device (DS90C383A/DS90CF383A) utilizes a different PLL architecture employing an internal 7X clock for enhanced pulse position control.

This device (DS90C383A/DS90CF383A) also features reduced variation of the TCCD parameter which is important for dual pixel applications. (See AN-1084) TCCD variation has been measured to be less than 250ps at 65MHz under normal operating conditions.

This device may also be used as a replacement for the DS90CF583 (5V, 65MHz) and DS90CF581 (5V, 40MHz) FPD-Link Transmitters with certain considerations/modifications:

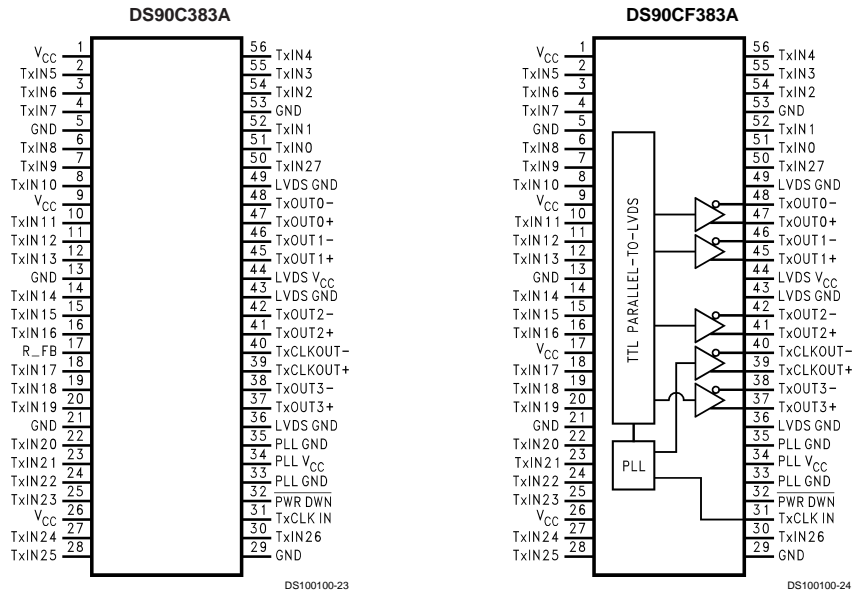
1. Change 5V power supply to 3.3V. Provide this supply to the V<sub>CC</sub>, LVDS V<sub>CC</sub> and PLL V<sub>CC</sub> of the transmitter.
2. The DS90C383A transmitter input and control inputs accept 3.3V TTL/CMOS levels. They are not 5V tolerant.
3. To implement a falling edge device for the DS90C383A, the R\_FB pin (pin 17) may be tied to ground OR left unconnected (an internal pull-down resistor biases this pin low). Biasing this pin to V<sub>CC</sub> implements a rising edge device.

## 10.0 Transmitter Clock Jitter Cycle-to-Cycle

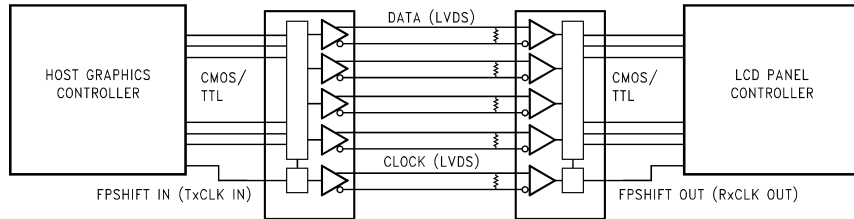
Figures 12 and 13 illustrate the timing of the input clock relative to the input data. The input clock (TxCLKin) is intentionally shifted to the left -3ns and +3ns to the right when data (Txin0-27) is high. This 3ns of cycle-to-cycle clock jitter is re-

peated at a period of 2 $\mu$ s, which is the period of the input data (1 $\mu$ s high, 1 $\mu$ s low). At different operating frequencies the N Cycle is changed to maintain the desired 3ns cycle-to-cycle jitter at 2 $\mu$ s period.

## 11.0 Pin Diagram



### Application

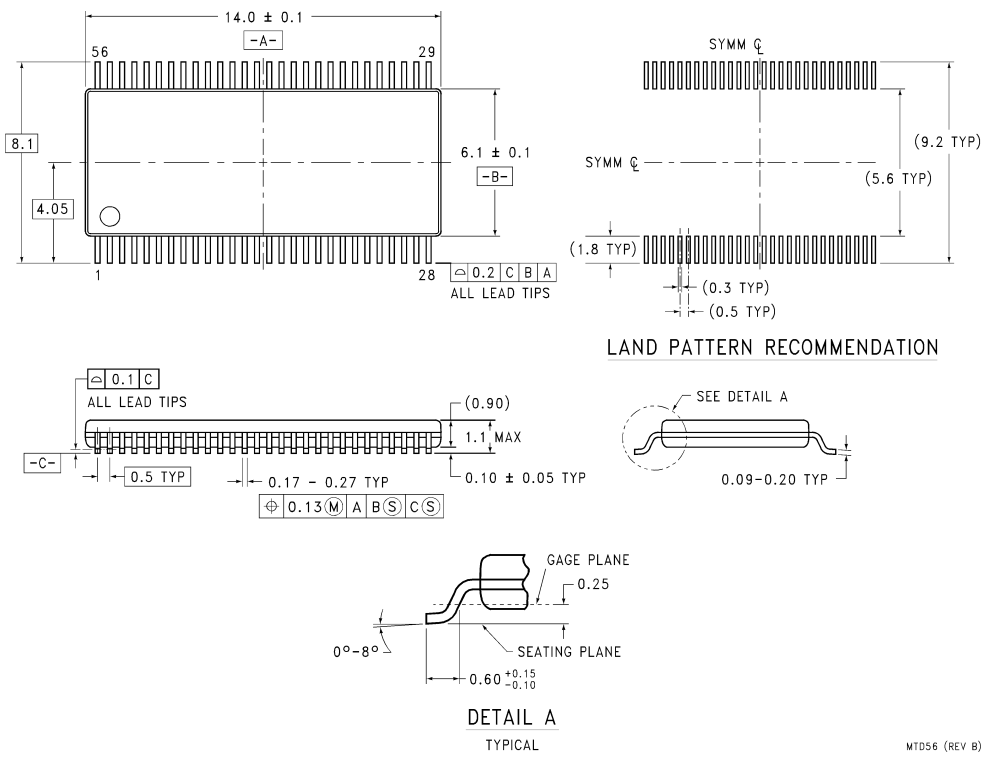


**TABLE 1. Programmable Transmitter (DS90C383A)**

Pin	Condition	Strobe Status
R_FB	R_FB = V <sub>CC</sub>	Rising edge strobe
R_FB	R_FB = GND or NC	Falling edge strobe

**DS90C383A/DS90CF383A +3.3V Programmable LVDS Transmitter 24-Bit Flat Panel Display (FPD) Link-65 MHz**

**12.0 Physical Dimensions** inches (millimeters) unless otherwise noted



**56-Lead Molded Thin Shrink Small Outline Package, JEDEC**  
**Order Number DS90C383AMTD, DS90CF383AMTD**  
**NS Package Number MTD56**

MTD56 (REV B)

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